

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	I _{PP_I/O}	±6	Α	I/O to V _{SS} , 8/20 μs
Peak Pulse Power, per IEC 61000-4-5	P _{PP_I/O}	55	W	I/O to V _{SS} , 8/20 µs
Operating Voltage (DC)	V_{DC}	5.5	V	I/O to V _{SS}
ESD Protection – Contact Discharge, per IEC 61000-4-2	V _{ESD_I/O}	±16	kV	I/O to V _{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	V _{ESD_I/O}	+27/-19	kV	I/O to V _{SS}
Operating Temperature	T _{OP}	-55 to +85	°C	
Storage Temperature	T _{STG}	-55 to +150	°C	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{\theta JA}$	417	°C/W

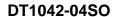
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	VRWM		—	5.0	V	V _{CC} to V _{SS}
Reverse Current (Note 6)	I _{R(Vcc to Vss)}		_	1.0	μA	$V_R = V_{RWM} = 5V$, V_{CC} to V_{SS}
Reverse Current (Note 6)	I _{R(IO to Vss)}		_	0.5	μA	V _R = V _{RWM} = 5V, any I/O to V _{SS}
Reverse Breakdown Voltage	V _{BR}	6.2	_		V	I _R = 1mA, V _{CC} to V _{SS}
Forward Clamping Voltage	V _F	-1.0	-0.8		V	I _F = -15mA, V _{CC} to V _{SS}
Reverse Clamping Voltage(Note 7)	V _{C_Vcc}		6.3	_	V	I _{PP} = 9A, V _{CC} to V _{SS} , 8/20 μs
	V _{C_I/O}	_	7.7	9	V	I _{PP} = 6A, I/O to V _{SS} , 8/20 μs
ESD Clamping Voltage	V _{ESD_Vcc}		6.8	_	V	TLP, 10A, tp = 100 ns, V_{CC} to V_{SS} , per Fig. 8
	V _{ESD_I/O}	_	9	_	V	TLP, 10A, tp = 100 ns, I/O to V _{SS} , per Fig. 8
Dynamic Resistance	R _{DIF_Vcc}	_	0.1	_	Ω	TLP, 10A, tp = 100 ns, V _{CC} to V _{SS}
	R _{DIF_I/O}		0.25		Ω	TLP, 10A, tp = 100 ns, I/O to V _{SS}
Channel Input Capacitance	C _{I/O to} V _{SS}	_	0.65	0.8	pF	V _R = 2.5V, V _{CC} = 5V, f = 1MHz
Variation of Channel Input Capacitance	$\Delta C_{I/O}$	_	0.02		pF	V _{CC} = 5V, V _{SS} = 0V, I/O = 2.5V, f =1MHz, T=+25°C, I/O_x to V _{SS} - I/O_y to V _{SS}

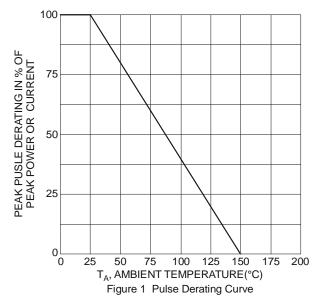
Notes:

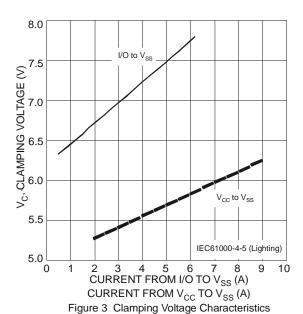
- 5. Device mounted on Polymide PCB pad layout (2oz copper) as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

 6. Short duration pulse test used to minimize self-heating effect.
- 7. Clamping voltage value is based on an 8x20µs peak pulse current (Ipp) waveform.









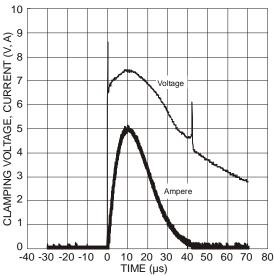


Figure 5 Waveform of Clamping Voltage, Current vs. Time (8/20µs, I/O to V_{SS})

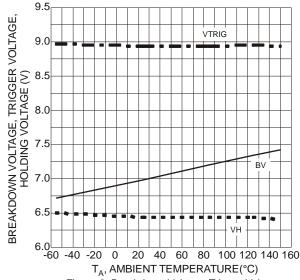
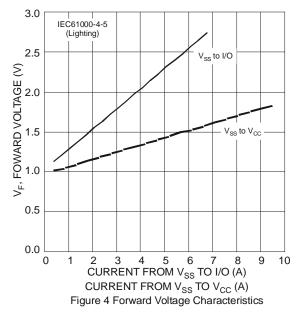


Figure 2 Breakdown Voltage, Trigger Voltage, Holding Voltage vs. Ambient Temperature

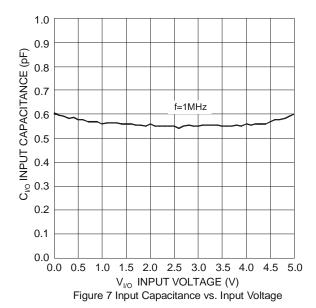


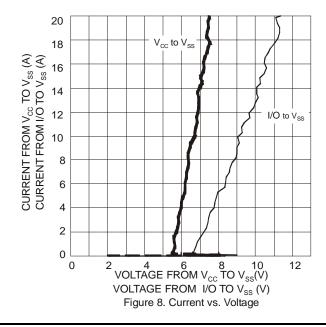
10 CLAMPING VOLTAGE, CURRENT (V, A) 8 7 Voltage 6 5 3 2 -30 -20 -10 10 20 30 40 50 60 0 TIME (µs)

Figure 6 Waveform of Clamping Voltage, Current vs. Time (8/20 μ s, V_{CC} to V_{SS})

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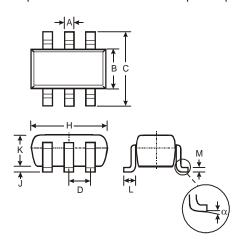






Package Outline Dimensions

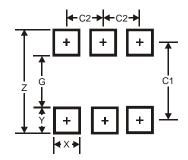
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT26					
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
С	2.70	3.00	2.80		
D	_		0.95		
Н	2.90	3.10	3.00		
7	0.013	0.10	0.05		
K	1.00	1.30	1.10		
L	0.35	0.55	0.40		
М	0.10	0.20	0.15		
α	0°	8°	_		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Υ	0.80
C1	2.40
C2	0.95



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